## NSN 5962-01-135-1855

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View Online at https://aerobasegroup.com/nsn/5962-01-135-1855

Overall Length:
1.290 inches
Overall Height:
0.425 inches
Overall Width:
0.620 inches
Body Length:
1.290 inches
Body Width:
0.610 inches
Body Height:
0.210 inches
Maximum Power Dissipation Rating:
950.0 milliwatts
Operating Tempurature Range:
-55.0/+125.0 degrees celsius
Storage Tempurature Range:
-65.0/+150.0 degrees celsius
Features Provided:
Bipolar and burn in and monolithic and electrostatic sensitive and programmed and schottky
Inclosure Material:
Ceramic
Inclosure Configuration:
Dual-in-line
Output Logic Form:
Complementary-metal oxide-semiconductor logic
Input Circuit Pattern:
11 input
Case Outline Source And Designator:
D-3 mil-m-38510
Terminal Surface Treatment:
Solder
Voltage Rating And Type Per Characteristic:
-0.5 volts power source and 7.0 volts power source
Memory Device Type:
Rom
Test Data Document:
96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.).
Terminal Type And Quantity:
24 printed circuit
Shelf Life:

N/a

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**Unit Of Measure:** 

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Demilitarization:

Yes - demil/mli

Fiig:

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